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S-8225B Series

Accuracy ±50 mV

BATTERY MONITORING IC FOR 3-SERIAL TO 5-SERIAL CELL PACK

Accuracy $\pm 20 \text{ mV}$ (Ta = $+25^{\circ}$ C), $\pm 30 \text{ mV}$ (Ta = 0° C to $+60^{\circ}$ C)

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The S-8225B Series includes high-accuracy voltage detection circuits and delay circuits, and can monitor the status of 3-serial to 5-serial cell lithium-ion rechargeable battery in single use. By switching the voltage level which is applied to the SEL1 pin and SEL2 pin, users are able to use the S-8225B Series for 3-serial to 5-serial cell pack.

3.5 V to 4.4 V (50 mV step)

3.3 V to 4.4 V^{*1}

Features

www.sii-ic.com

 High-accuracy voltage detection function for each cell Overcharge detection voltage n (n = 1 to 5)

Overcharge release voltage n (n = 1 to 5) Overdischarge detection voltage n (n = 1 to 5) Overdischarge release voltage n (n = 1 to 5)

- ge detection voltage n (n = 1 to 5)2.2 V to 3.2 V (100 mV step)Accuracy $\pm 80 \text{ mV}$ ge release voltage n (n = 1 to 5)2.2 V to 3.4 V^{*2} Accuracy $\pm 100 \text{ mV}$
- Overcharge detection delay time and overdischarge detection delay time can be set by external capacitor.
- Switchable between 3-serial to 5-serial cell by using the SEL1 pin and the SEL2 pin
- The CO pin and the DO pin are controlled by the CTLC pin and the CTLD pin, respectively.
- Output voltage of the CO pin and the DO pin is limited to 12 V max.
- Output logic is selectable.
 High-withstand voltage
 Wide operation voltage range
 Wide operation temperature range
 Low current consumption
 During operation (V1 = V2 = V3 = V4 = V5 = 3.4 V)
 During power-down (V1 = V2 = V3 = V4 = V5 = 1.6 V)
 3.0 μA max. (Ta = +25°C)
- Lead-free (Sn 100%), halogen-free
- *1. Overcharge hysteresis voltage n (n = 1 to 5) is selectable in 0 V, or in 0.1 V to 0.4 V in 50 mV step. (Overcharge hysteresis voltage = Overcharge detection voltage Overcharge release voltage)
- *2. Overdischarge hysteresis voltage n (n = 1 to 5) is selectable in 0 V, or in 0.2 V to 0.7 V in 100 mV step. (Overdischarge hysteresis voltage = Overdischarge release voltage – Overdischarge detection voltage)

Application

• Lithium-ion rechargeable battery pack

Package

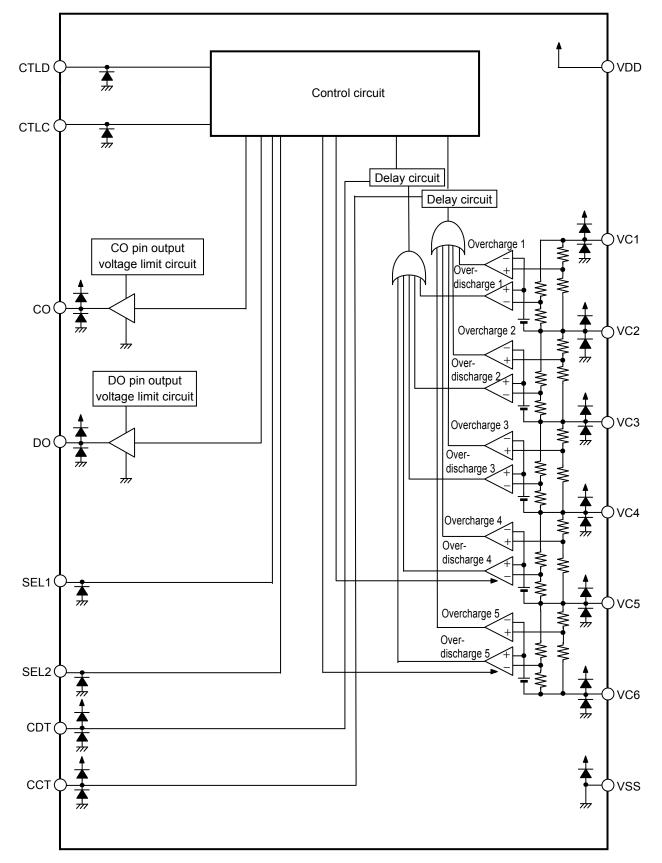
• 16-Pin TSSOP



BATTERY MONITORING IC FOR 3-SERIAL TO 5-SERIAL CELL PACK S-8225B Series

Rev.1.5_01

Block Diagram

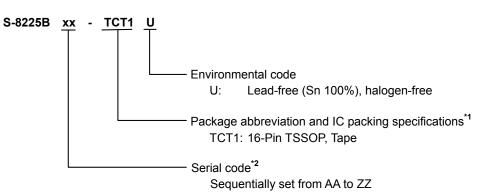


Remark Diodes in the figure are parasitic diodes.



Product Name Structure

1. Product name



- *1. Refer to the tape drawing.
- *2. Refer to "3. Product name list".

2. Package

Table 1 Package Drawing Codes

Package Name	Dimension	Таре	Reel
16-Pin TSSOP	FT016-A-P-SD	FT016-A-C-SD	FT016-A-R-S1

3. Product name list

Table 2

Product Name	Overcharge Detection Voltage [Vcu]	Overcharge Release Voltage [VcL]	Overdischarge Detection Voltage [V _{DL}]	Overdischarge Release Voltage [V _{DU}]	CO Pin Output Logic	DO Pin Output Logic	0 V Battery Detection Function
S-8225BAA-TCT1U	4.220 V	4.170 V	2.30 V	2.30 V	Active "H"	Active "L"	Unavailable
S-8225BAB-TCT1U	3.600 V	3.550 V	2.20 V	2.20 V	Active "H"	Active "L"	Unavailable
S-8225BAC-TCT1U	4.450 V	4.050 V	2.50 V	2.70 V	Active "H"	Active "L"	Unavailable
S-8225BAE-TCT1U	4.250 V	4.200 V	2.70 V	3.00 V	Active "H"	Active "H"	Unavailable
S-8225BAF-TCT1U	4.250 V	4.200 V	2.50 V	2.70 V	Active "H"	Active "H"	Unavailable
S-8225BAG-TCT1U	4.275 V	4.225 V	2.30 V	2.80 V	Active "H"	Active "H"	Unavailable
S-8225BAH-TCT1U	3.900 V	3.600 V	2.20 V	2.40 V	Active "H"	Active "H"	Available
S-8225BAI-TCT1U	4.195 V	4.195 V	2.50 V	3.00 V	Active "H"	Active "H"	Available
S-8225BAJ-TCT1U	4.170 V	4.170 V	2.50 V	3.00 V	Active "H"	Active "H"	Available

Remark Please contact our sales office for products with detection voltage values other than those specified above.

Pin Configuration

1. 16-Pin TSSOP

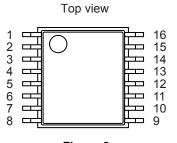


Figure 2

Table 3

Pin No.	Symbol	Description
1	CTLD	DO control pin
2	CTLC	CO control pin
3	СО	Output pin for overcharge detection
4	DO	Output pin for overdischarge detection
5	SEL1	Switching ning for 2 parial to 5 parial call*1
6	SEL2	Switching pins for 3-serial to 5-serial cell*1
7	CDT	Capacitor connection pin for delay for overdischarge detection voltage
8	CCT	Capacitor connection pin for delay for overcharge detection voltage
9	VSS	Input pin for negative power supply,
9	V33	connection pin for negative voltage of battery 5
10	VC6	Connection pin for negative voltage of battery 5
11	VC5	Connection pin for negative voltage of battery 4,
	VC5	connection pin for positive voltage of battery 5
12	VC4	Connection pin for negative voltage of battery 3,
12	VC4	connection pin for positive voltage of battery 4
13	VC3	Connection pin for negative voltage of battery 2,
15	VC3	connection pin for positive voltage of battery 3
14	VC2	Connection pin for negative voltage of battery 1,
14	V02	connection pin for positive voltage of battery 2
15	VC1	Connection pin for positive voltage of battery 1
16	VDD	Input pin for positive power supply,
10		connection pin for positive voltage of battery 1

*1. Refer to "7. SEL pin" in "■ Operation" for setting of the SEL1 pin and the SEL2 pin.

Absolute Maximum Ratings

Table	4
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		(Та	a = +25°C unless otherwise sp	ecified
Item	Symbol	Applied Pin	Absolute Maximum Rating	Unit
Input voltage between VDD pin and VSS pin	V _{DS}	VDD	$V_{\rm SS}$ – 0.3 to $V_{\rm SS}$ + 28	v
Input pin voltage	Vin	VC1, VC2, VC3, VC4, VC5, VC6, SEL1, SEL2, CTLC, CTLD, CCT, CDT	$V_{\text{SS}} - 0.3$ to $V_{\text{DD}} + 0.3$	v
Output pin voltage	Vout	DO, CO	$V_{SS} - 0.3$ to $V_{DD} + 0.3$	V
Power dissipation	PD	-	1100 ^{*1}	mW
Operation ambient temperature	Topr	_	-40 to +85	°C
Storage temperature	T _{stg}	_	-40 to +125	°C

*1. When mounted on board

[Mounted board]

(1) Board size: 114.3 mm \times 76.2 mm \times t1.6 mm

(2) Board name: JEDEC STANDARD51-7

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

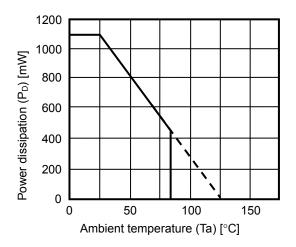


Figure 3 Power Dissipation of Package (When Mounted on Board)

Electrical Characteristics

(Ta = $+25^{\circ}$ C, V _{DS} = V _{DD} - V _{SS} = V1 + V2 + V3 + V4 + V5 unless otherwise specified)							
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Detection Voltage							
Overcharge detection voltage n	Vcun	Ta = +25°C V1 = V2 = V3 = V4 = V5 = V _{CU} – 0.05 V	V _{CUn} - 0.020	Vcun	V _{CUn} + 0.020	V	1
(n = 1, 2, 3, 4, 5)	V CUn	Ta = 0°C to +60°C*1 V1 = V2 = V3 = V4 = V5 = V _{CU} – 0.05 V	V _{CUn} - 0.030	Vcun	V _{CUn} + 0.030	V	1
Overcharge release voltage n (n = 1, 2, 3, 4, 5)	V _{CLn}	-	V _{CLn} - 0.050	VCLn	V _{CLn} + 0.050	V	1
Overdischarge detection voltage n (n = 1, 2, 3, 4, 5)	VDLn	-	V _{DLn} - 0.08	VDLn	V _{DLn} + 0.08	V	1
Overdischarge release voltage n (n = 1, 2, 3, 4, 5)	VDUn	-	V _{DUn} - 0.10	VDUn	V _{DUn} + 0.10	V	1
0 V battery detection voltage n (n = 1, 2, 3, 4, 5)	Voinhn	0 V battery detection function "available"	0.4	0.7	1.1	V	1
Delay Time Function ^{*2}	1		1				
Overcharge detection delay time	t _{cu}	C _{CCT} = 0.1 μF	0.67	1.00	1.33	S	2
Overdischarge detection delay time	t⊔	C _{CDT} = 0.1 μF	0.67	1.00	1.33	S	2
CCT pin voltage	Vсст	_	-	1.5	5.0	V	2
CDT pin voltage	V _{CDT}	_	-	1.5	5.0	V	2
Input Voltage							
Operation voltage between VDD pin and VSS pin	V _{DSOP}	Fixed output voltage of CO pin and DO pin	4	-	26	V	_
CTLC pin voltage "H"	VCTLCH	_	$V_{\text{DS}}-4.0$	-	$V_{\text{DS}}-0.5$	V	3
CTLC pin voltage "L"	VCTLCL	_	0.5	-	4.0	V	3
CTLD pin voltage "H"	VCTLDH	-	$V_{\text{DS}}-4.0$	-	$V_{\text{DS}}-0.5$	V	3
CTLD pin voltage "L"	VCTLDL	_	0.5	-	4.0	V	3
SEL1 pin voltage "H"	V _{SELH1}	_	$V_{\text{DS}} \times 0.8$	_	-	V	3
SEL2 pin voltage "H"	V _{SELH2}	_	$V_{\text{DS}} \! \times \! 0.8$	_	-	V	3
SEL1 pin voltage "L"	V _{SELL1}	_	-	-	$V_{\text{DS}}\!\times\!0.2$	V	3
SEL2 pin voltage "L"	V _{SELL2}	_	-	-	$V_{\text{DS}}\!\times\!0.2$	V	3
Output Voltage		_					
CO pin voltage "H"	Vсон	_	5.0	8.0	12.0	V	4
DO pin voltage "H"	VDOH	-	5.0	8.0	12.0	V	4
Input Current	1	–					
Current consumption during operation	IOPE	V1 = V2 = V3 = V4 = V5 = 3.4 V	-	12	20	μA	5
Current consumption during power-down	Ipdn	V1 = V2 = V3 = V4 = V5 = 1.6 V	_	1.6	3.0	μA	5
VC1 pin current	Ivc1	V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V7 = V _{DS} , V8 = V9 = 0 V	-	0.4	0.8	μA	6
VC2 to VC5 pins current	Ivc2 to Ivc5	V1 = V2 = V3 = V4 = V5 = 3.4 V, $V6 = V7 = V_{DS}, V8 = V9 = 0 V$	-1.0	-	1.0	μA	6
VC6 pin current	I _{VC6}	$ \begin{array}{l} V1 = V2 = V3 = V4 = V5 = 3.4 \text{ V}, \\ V6 = V7 = V_{DS}, V8 = V9 = 0 \text{ V} \\ V1 = V2 = V3 = V4 = V5 = 3.4 \text{ V}, \end{array} $	-3.0	-1.0	-	μA	6
CTLC pin current "H"	Істісн	V6 = V7 = V _{DS} , V8 = V9 = 0 V	_	-	0.1	μA	6
CTLC pin current "L"	ICTLCL	V1 = V2 = V3 = V4 = V5 = 3.4 V, V7 = V _{DS} , V6 = V8 = V9 = 0 V	-0.1	_	-	μA	6

Table 5 (1 / 2)

$(Ta = +25^{\circ}C, V_{DS} = V_{DD} - V_{SS} = V1 + V2 + V3 + V4 + V5$ unless otherwise specifie						ecified)	
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
CTLD pin current "H"	ICTLDH	V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V7 = V _{DS} , V8 = V9 = 0 V	-	-	0.1	μA	6
CTLD pin current "L"	ICTLDL	V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V _{DS} , V7 = V8 = V9 = 0 V	-0.1	_	_	μΑ	6
SEL1 pin current "H"	I _{SELH1}	V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V7 = V8 = V _{DS} , V9 = 0 V	-	_	0.1	μA	6
SEL2 pin current "H"	I _{SELH2}	V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V7 = V9 = V _{DS} , V8 = 0 V	_	_	0.1	μΑ	6
SEL1 pin current "L"	I _{SELL1}	V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V7 = V _{DS} , V8 = V9 = 0 V	-0.1	_	-	μA	6
SEL2 pin current "L"	ISELL2	V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V7 = V _{DS} , V8 = V9 = 0 V	-0.1	_	_	μA	6
Output Current (CO Pin Outpu	t Logic Act	ive "H")					-
CO pin source current	Iсон	_	-	-	-10	μA	7
CO pin sink current	I _{COL}	_	10	_	-	μA	7
Output Current (CO Pin Outpu	t Logic Act	ive "L")					
CO pin source current	I _{COH}	_	-	-	-10	μA	7
CO pin sink current	I _{COL}	_	10	-	_	μA	7
Output Current (DO Pin Outpu	t Logic Act	ive "H")					
DO pin source current	IDOH	_	_	-	-10	μA	7
DO pin sink current	IDOL	_	10	-	-	μA	7
Output Current (DO Pin Outpu	t Logic Act	ive "L")					
DO pin source current	I _{DOH}	_	-	_	-10	μA	7
DO pin sink current	IDOL	_	10	-	_	μA	7

Table 5 (2 / 2)

*1. Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

*2. Refer to "6. Delay time setting" in "■ Operation" for details of the delay time function.

Test Circuits

 Overcharge detection voltage (V_{CUn}), overcharge release voltage (V_{CLn}), overdischarge detection voltage (V_{DLn}), overdischarge release voltage (V_{DUn}) (Test circuit 1)

 V_{CU1} is defined as the voltage V1 when V1 is gradually increased and the CO pin output becomes detection status after setting V1 = V2 = V3 = V4 = V5 = $V_{CU} - 0.05$ V. After that, V_{CL1} is defined as the voltage V1 when V1 is gradually decreased and the CO pin output becomes release status after setting V2 = V3 = V4 = V5 = 3.2 V. Moreover, V_{DL1} is defined as the voltage V1 when V1 is gradually decreased and the DO pin output becomes detection status after setting V1 = V2 = V3 = V4 = V5 = 3.5 V. After that, V_{DU1} is defined as the voltage V1 when V1 is gradually increased and the DO pin output becomes release status. Similarly, V_{CUn} , V_{CLn} , V_{DLn} and V_{DUn} can be defined by changing Vn (n = 2 to 5).

2. 0 V battery detection voltage (V_{0INHn}) (0 V battery detection function "available") (Test circuit 1)

 V_{0INH1} is defined as the voltage V1 when V1 is gradually decreased and the CO pin output becomes detection status after setting V1 = V2 = V3 = V4 = V5 = 3.4 V. Similarly, V_{0INHn} can be defined by changing Vn (n = 2 to 5).

3. Overcharge detection delay time (t_{CU}), overdischarge detection delay time (t_{DL}) (Test circuit 2)

 t_{CU} is defined as the time period from when V1 changes from 3.4 V to 4.5 V to when the CO pin output becomes detection status after setting V1 = V2 = V3 = V4 = V5 = 3.4 V.

Moreover, t_{DL} is defined as the time period from when V1 changes from 3.4 V to 1.6 V to when the DO pin output becomes detection status after setting V1 = V2 = V3 = V4 = V5 = 3.4 V.

4. CCT pin voltage (V_{CCT}), CDT pin voltage (V_{CDT}) (Test circuit 2)

 V_{CCT} is defined as the voltage between the CCT pin and the VSS pin during the time period when V1 changes from 3.4 V to 4.5 V to when the CO pin output becomes detection status after setting V1 = V2 = V3 = V4 = V5 = 3.4 V. Moreover, V_{CDT} is defined as the voltage between the CDT pin and the VSS pin during the time period when V1 changes from 3.4 V to 1.6 V to when the DO pin output becomes detection status after setting V1 = V2 = V3 = V4 = V5 = 3.4 V.

5. CTLC pin voltage "H" (VCTLCH), CTLC pin voltage "L" (VCTLCL), CTLD pin voltage "H" (VCTLDH), CTLD pin voltage "L" (VCTLDL) (Test circuit 3)

 V_{CTLCL} is defined as the voltage V6 when V6 is gradually decreased and the CO pin output becomes detection status after setting V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V7 = V_{DS} (= V1 + V2 + V3 + V4 + V5), V8 = V9 = 0 V. After that, V_{CTLCH} is defined as the voltage V6 when V6 is gradually increased and the CO pin output becomes release status. Moreover, V_{CTLDL} is defined as the voltage V7 when V7 is gradually decreased and the DO pin output becomes detection status after setting V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V7 = V_{DS} (= V1 + V2 + V3 + V4 + V5), V8 = V9 = 0 V. After that, V_{CTLDL} is defined as the voltage V7 when V7 is gradually increased and the DO pin output becomes release status.

SEL1 pin voltage "H" (V_{SELH1}), SEL2 pin voltage "H" (V_{SELH2}), SEL1 pin voltage "L" (V_{SELL1}), SEL2 pin voltage "L" (V_{SELL2}) (Test circuit 3)

 V_{SELH1} is defined as the voltage V8 when V8 is gradually increased and the DO pin output becomes release status after setting V1 = V2 = V3 = V5 = 3.5 V, V4 = 0 V, V6 = V7 = V_{DS} (= V1 + V2 + V3 + V4 + V5), V8 = V9 = 0 V. After that, V_{SELL1} is defined as the voltage V8 when V8 is gradually decreased and the DO pin output becomes detection status.

Moreover, V_{SELH2} is defined as the voltage V9 when V9 is gradually increased and the DO pin output becomes release status after setting V1 = V2 = V3 = V4 = 3.5 V, V5 = 0 V, V6 = V7 = V_{DS} (= V1 + V2 + V3 + V4 + V5), V8 = V9 = 0 V. After that, V_{SELL2} is defined as the voltage V9 when V9 is gradually decreased and the DO pin output becomes detection status.

7. CO pin voltage "H" (V_{COH}), DO pin voltage "H" (V_{DOH}) (Test circuit 4)

7.1 CO pin output logic active "H"

 V_{COH} is defined as the voltage between the CO pin and the VSS pin when V1 = 6.8 V, V2 = 0 V, V3 = V4 = V5 = 3.4 V.

7.2 CO pin output logic active "L"

 V_{COH} is defined as the voltage between the CO pin and the VSS pin when V1 = V2 = V3 = V4 = V5 = 3.4 V.

7.3 DO pin output logic active "H"

 V_{DOH} is defined as the voltage between the DO pin and the VSS pin when V1 = 6.8 V, V2 = 0 V, V3 = V4 = V5 = 3.4 V.

7.4 DO pin output logic active "L"

 V_{DOH} is defined as the voltage between the DO pin and the VSS pin when V1 = V2 = V3 = V4 = V5 = 3.4 V.

8. CO pin source current (Iсон), CO pin sink current (IсоL), DO pin source current (IDOH), DO pin sink current (IDOL) (Test circuit 7)

8.1 CO pin output logic active "H"

 I_{COH} is defined as the CO pin current when V1 = 6.8 V, V2 = 0 V, V3 = V4 = V5 = 3.4 V, V6 = V_{COH} - 0.5 V. I_{COL} is defined as the CO pin current when V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = 0.5 V.

8. 2 CO pin output logic active "L"

 I_{COH} is defined as the CO pin current when V1 = V2 = V3 = V4 = V5 = 3.4 V, V6 = V_{COH} - 0.5 V. I_{COL} is defined as the CO pin current when V1 = 6.8 V, V2 = 0 V, V3 = V4 = V5 = 3.4 V, V6 = 0.5 V.

8.3 DO pin output logic active "H"

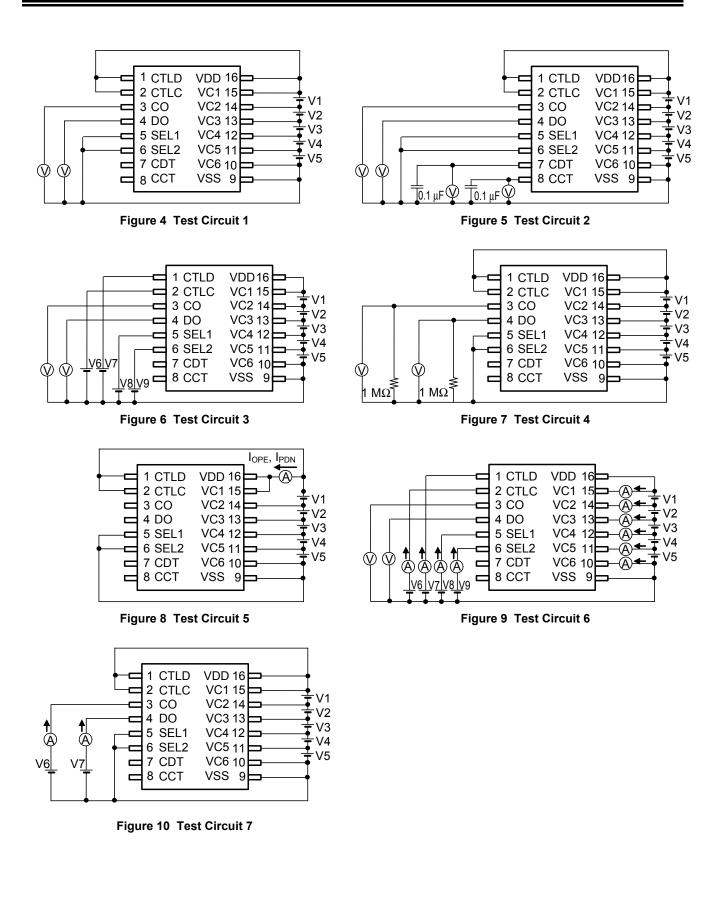
 I_{DOH} is defined as the DO pin current when V1 = 6.8 V, V2 = 0 V, V3 = V4 = V5 = 3.4 V, V7 = V_{DOH} - 0.5 V. I_{DOL} is defined as the DO pin current when V1 = V2 = V3 = V4 = V5 = 3.4 V, V7 = 0.5 V.

8.4 DO pin output logic active "L"

 I_{DOH} is defined as the DO pin current when V1 = V2 = V3 = V4 = V5 = 3.4 V, V7 = $V_{DOH} - 0.5 V$. I_{DOL} is defined as the DO pin current when V1 = 6.8 V, V2 = 0 V, V3 = V4 = V5 = 3.4 V, V7 = 0.5 V.

BATTERY MONITORING IC FOR 3-SERIAL TO 5-SERIAL CELL PACK S-8225B Series

Rev.1.5_01



Operation

Remark Refer to "■ Connection Examples of Battery Monitoring IC".

1. Normal status

When the voltage of each of the batteries is in the range from overcharge detection voltage (V_{CUn}) to overdischarge detection voltage (V_{DLn}), and the CTLC pin input voltage (V_{CTLC}) and the CTLD pin input voltage (V_{CTLD}) are higher than the CTLC pin voltage "H" (V_{CTLCH}) and the CTLD pin voltage "H" (V_{CTLDH}), respectively, the S-8225B Series defines the CO pin output voltage (V_{CO}) and the DO pin output voltage (V_{DO}) as "L" (output logic active "H") or "H" (output logic active "L"). This is called normal status.

 V_{CO} is defined as the CO pin voltage "H" (V_{COH}) when it is "H". Similarly, V_{DO} is defined as the DO pin voltage "H" (V_{DOH}) when it is "H".

2. Overcharge status

When the voltage of one of the batteries becomes V_{CUn} or higher, the CO pin output inverts and the S-8225B Series becomes detection status. This is called overcharge status.

When the voltage of each of the batteries becomes overcharge release voltage (V_{CLn}) or lower, the overcharge status is released and the S-8225B Series returns to normal status.

3. Overdischarge status

When the voltage of one of the batteries becomes V_{DLn} or lower, the DO pin output inverts and the S-8225B Series becomes detection status. This is called overdischarge status.

When the voltage of each of the batteries becomes overdischarge release voltage (V_{DUn}) or higher, the overdischarge status is released and the S-8225B Series returns to normal status.

4. CTLC pin and CTLD pin

The S-8225B Series has two pins to control.

The CTLC pin controls the output voltage from the CO pin; the CTLD pin controls the output voltage from the DO pin. Thus it is possible for users to control the output voltages from the CO pin and DO pin, respectively. These controls precede the battery protection circuit.

CTLC Pin	CO Pin
"H"* ¹	Normal status*3
"L"*2	Detection status

Table 6 Status Set by CTLC Pin

*1. "H": $CTLC \ge V_{CTLCH}$

*2. "L": $CTLC \leq V_{CTLCL}$

*3. The status is controlled by the voltage detection circuit.

Table 7 Status Set by CTLD Pin

CTLD Pin	DO Pin
"H"* ¹	Normal status*3
"L"*2	Detection status

*1. "H": CTLD ≥ V_{CTLDH}

*2. "L": $CTLD \leq V_{CTLDL}$

***3.** The status is controlled by the voltage detection circuit.

5. 0 V battery detection function

In the S-8225B Series, users are able to select a 0 V battery detection "available" function. If this optional function is selected, the CO pin becomes detection status when the voltage of one of the batteries becomes 0 V battery detection voltage (V_{0INHn}) or lower.

6. Delay time setting

When the voltage of one of the batteries becomes V_{CUn} or higher, the S-8225B Series charges the capacitor connected to the CCT pin rapidly up to the CCT pin voltage (V_{CCT}). After that, The S-8225B Series discharges the capacitor with the constant current of 100 nA, and the CO pin output is defined as detection status at the time when the CCT pin voltage falls to a certain level or lower. The overcharge detection delay time (t_{CU}) changes depending on the capacitor connected to the CCT pin.

 $t_{\mbox{CU}}$ is calculated by the following formula.

$$t_{CU}$$
 [s] = (6.7, 10, 13.3) × C_{CCT} [µF]

Similarly, the overdischarge detection delay time (t_{DL}) changes depending on the capacitor connected to the CDT pin. t_{DL} is calculated by the following formula.

$$t_{DL}$$
 [s] = (6.7, 10, 13.3) × C_{CDT} [µF]

Since the S-8225B Series charges the capacitor for delay rapidly, the voltage of the CCT pin and the CDT pin becomes large if the capacitance value is small. As a result, a variation between the calculated value of the delay time and the actual delay time is generated.

If the capacitance value is so large that the rapid charging can not be finished within the internal delay time, the output pin becomes detection status simultaneously with the end of internal delay time.

In addition, the charging current to the capacitor for delay passes through the VDD pin. Therefore, a large resistor connected to the VDD pin results in a big drop of the power supply voltage at the time of rapid charging which causes malfunction.

Regarding the recommended values for external components, refer to "Table 9 Constants for External Components".

7. SEL pin

In the S-8225B Series, switchable monitoring control between 3-cell to 5-cell is possible by using the SEL1 pin and the SEL2 pin. For example, since the overdischarge detection of V4 or V5 is prohibited and the overdischarge is not detected even if V4 or V5 is shorted when the SEL1 pin is "H" and the SEL2 pin is "L", the S-8225B Series can be used for 3-cell monitoring.

Be sure to use the SEL1 pin and the SEL2 pin at "H" or "L" potential.

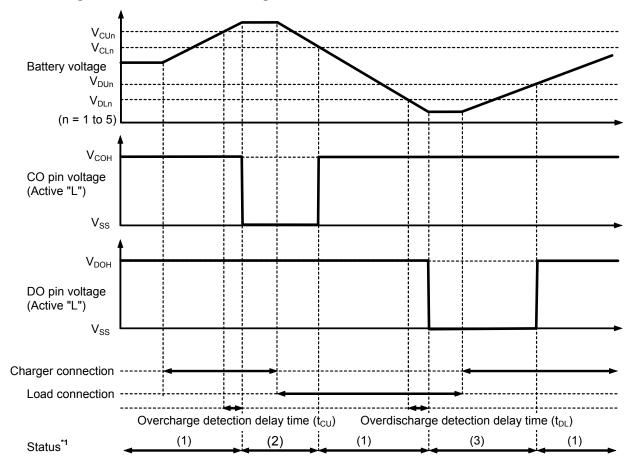
	_	
SEL1 pin	SEL2 pin	Setting
"H"* ¹	"H"*1	Prohibition
"H"* ¹	"L"* ²	3-cell monitoring
"L"*2	"H" ^{*1}	4-cell monitoring
" "*2	" "*2	5-cell monitoring

Table 8 Settings of SEL1 Pin and SEL2 Pin

*1. "H": SEL1 \geq V_{SELH1} and SEL2 \geq V_{SELH2}

*2. "L": SEL1 \leq V_{SELL1} and SEL2 \leq V_{SELL2}

Timing Charts



1. Overcharge detection and overdischarge detection

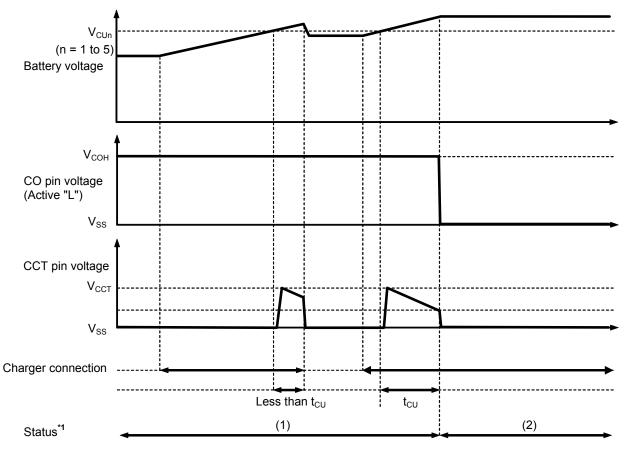
*1. (1): Normal status

(2): Overcharge status

(3): Overdischarge status

Figure 11

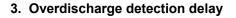
2. Overcharge detection delay

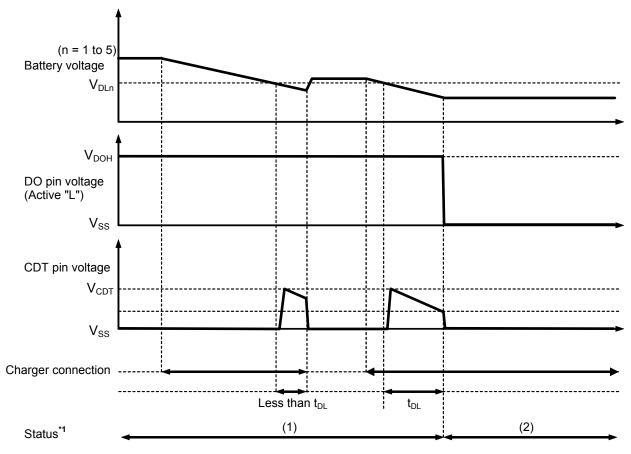


*1. (1): Normal status

(2): Overcharge status

Figure 12





*1. (1): Normal status

(2): Overdischarge status

Figure 13

■ Connection Examples of Battery Monitoring IC

1. 5-serial cell

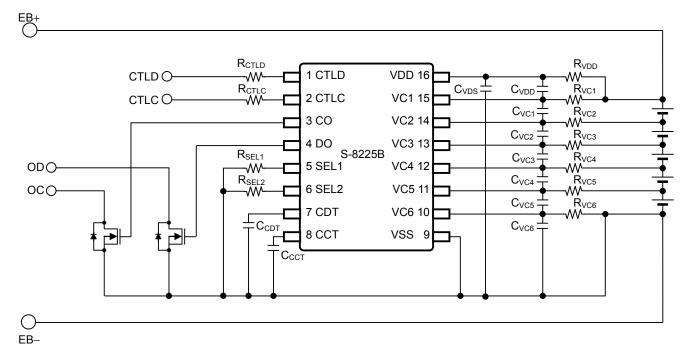


Figure 14

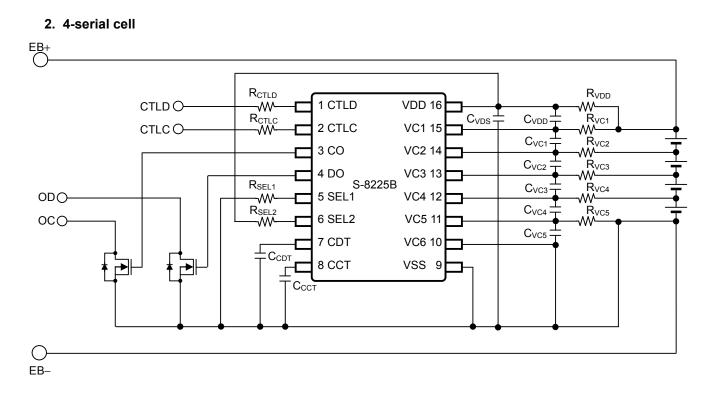


Figure 15

Remark Regarding the recommended values for external components, refer to "Table 9 Constants for External Components".

3. 3-serial cell

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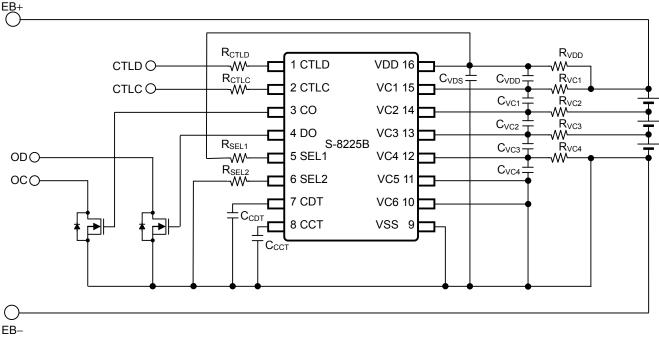


Figure 16

Remark Regarding the recommended values for external components, refer to "Table 9 Constants for External Components".

Symbol	Min.	Тур.	Max.	Unit
Rvdd	50	100	1000	Ω
Rvcn	0.5	1	2	kΩ
C _{VDS}	0.01	0.1	1	μF
CVDD	_	0	1	μF
CvCn	0.01	0.1	1	μF
Ссст	0.001	0.1	0.22	μF
CCDT	0.001	0.1	0.22	μF
RCTLC, RCTLD	_	1	_	kΩ
Rsel1, Rsel2	0.5	1	_	kΩ

Table 9 Constants for External Components

Caution 1. The above constants may be changed without notice.

- 2. The example of connection shown above and the constant do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constant.
- 3. Rvc1 to Rvc6 and Cvc1 to Cvc6 should be the same constant, respectively.
- 4. Set up Rvcn and Cvcn as $Rvcn \times Cvcn \ge 50 \times 10^{-6}$.
- 5. Set up R_{VDD} and C_{VDS} as $5\times10^{-6} \le R_{VDD}\times C_{VDS} \le 100\times10^{-6}.$
- 6. Set $(R_{VDD} \times C_{VDS}) / (R_{VCn} \times C_{VCn}) = 0.1$.

Remark n = 1 to 6

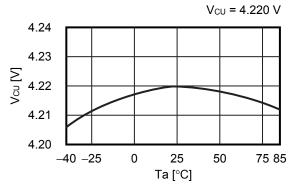
Precautions

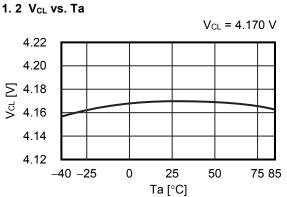
- The application conditions for the input voltage, output voltage, and load current should not exceed the package power dissipation.
- If both an overcharge battery and an overdischarge battery are included among the whole batteries, the condition is set in overcharge status and overdischarge status. Therefore either charging or discharging is impossible.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- SII Semiconductor Corporation claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

Characteristics (Typical Data)

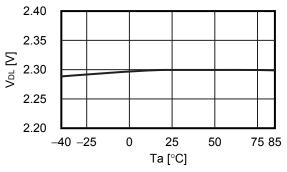
- 1. Detection voltage
 - 1. 1 V_{CU} vs. Ta

1.3 V_{DL} vs. Ta



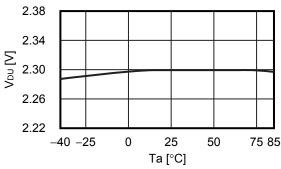






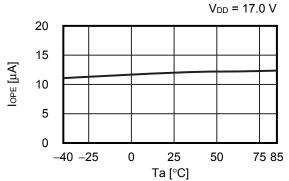




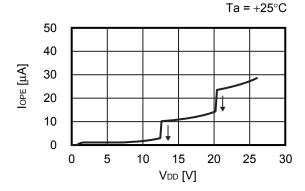


2. Current consumption

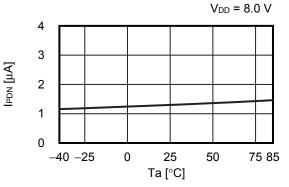
2.1 IOPE vs. Ta



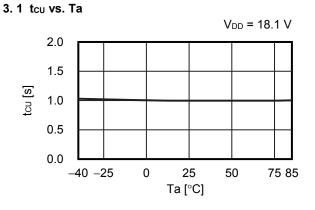
2. 3 IOPE VS. VDD

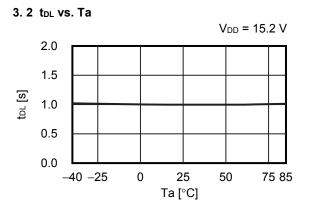


2. 2 IPDN vs. Ta

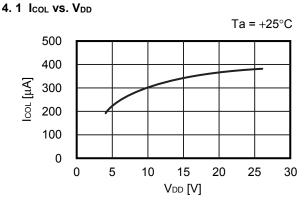


3. Delay time



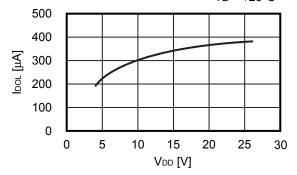


4. Output current





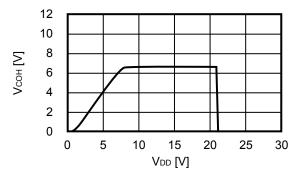




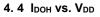
5. Output voltage

5.1 VCOH VS. VDD

Ta = $+25^{\circ}$ C, CO pin output logic active "L", V_{CU} = 4.220 V 0 V battery detection function "unavailable"

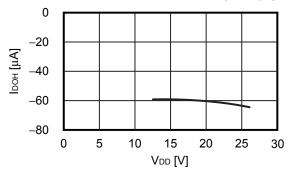


 $Ta = +25^{\circ}C$ $Ta = +25^{\circ}C$ Ta = -20 -20 -40 -60 -80 0 5 10 15 20 25 30 $V_{DD} [V]$



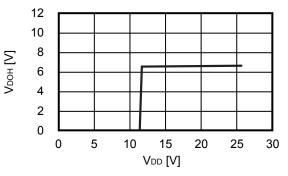
4.2 ICOH VS. VDD

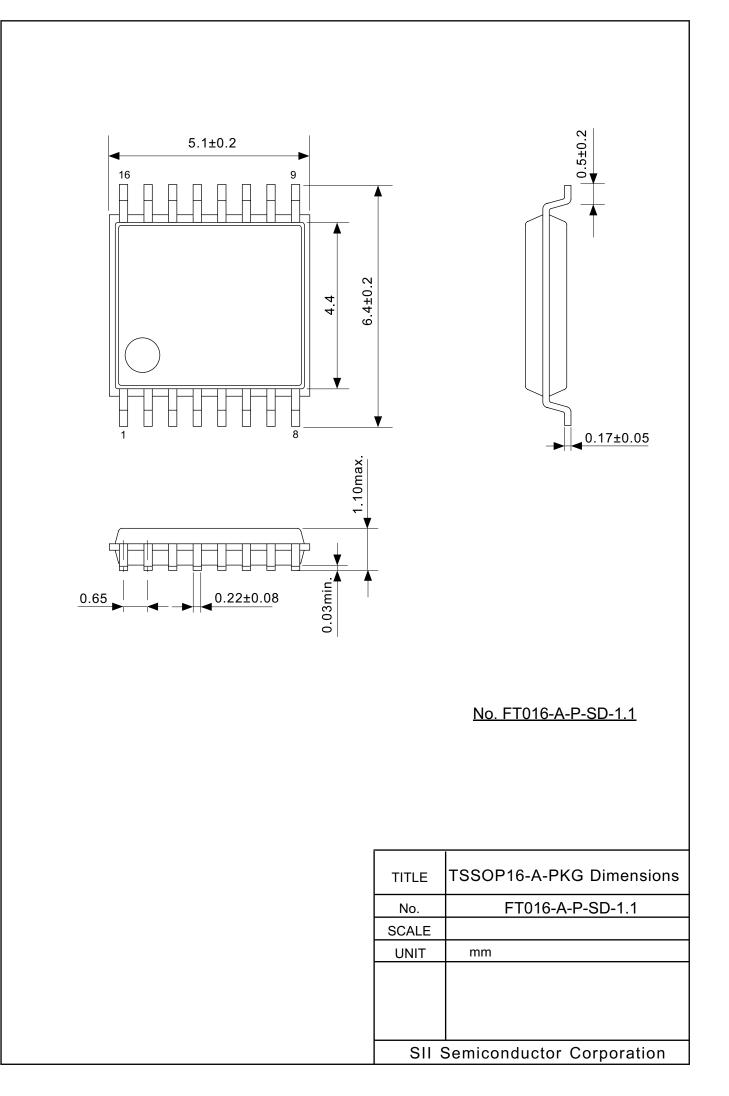
Ta = +25°C

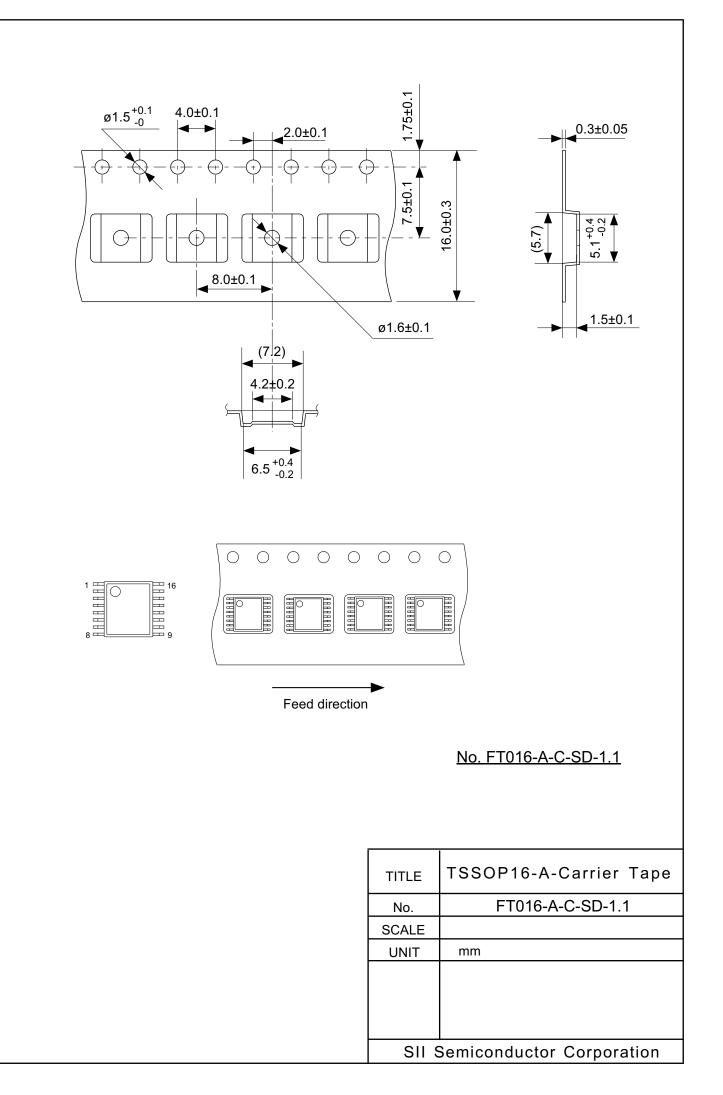


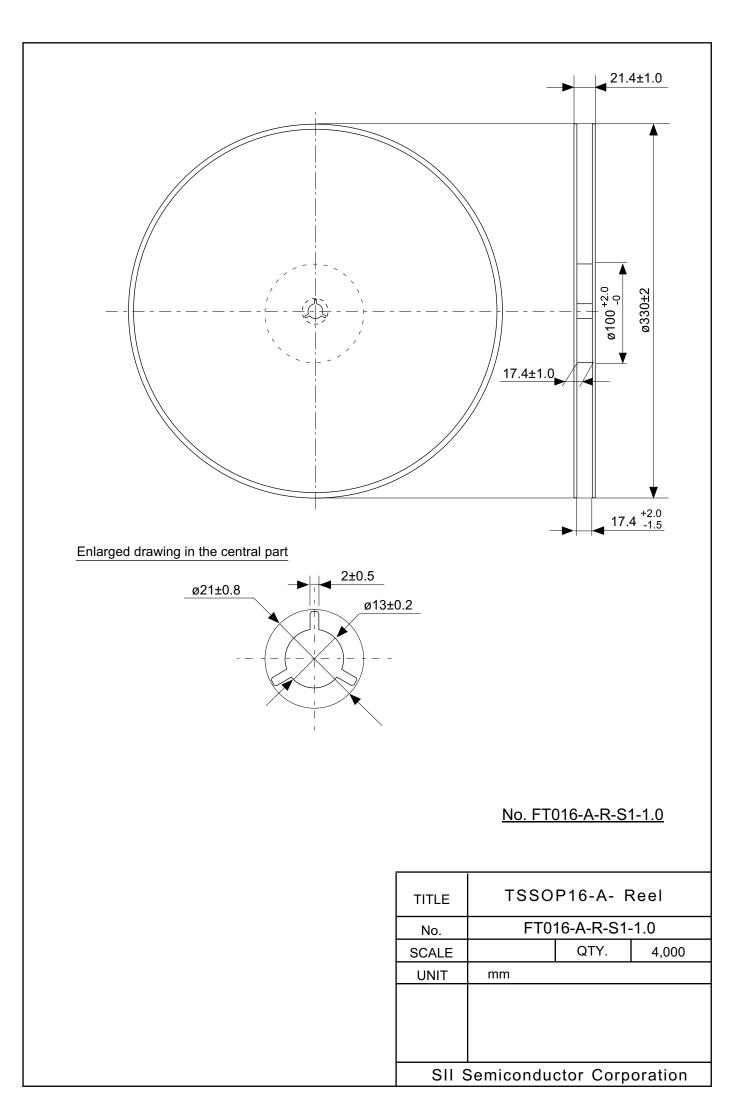
5. 2 VDOH VS. VDD

Ta = +25°C, DO pin output logic active "L" $$V_{\text{DL}}$$ = 2.30 V









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